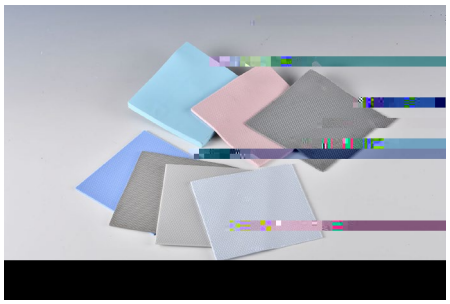
Thermal GP0300

TDS A1 2024.12



Thermal GP0300

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Thermal GP0300 thermal conductive silicone gap pad is a kind of material with high thermal conductivity. Owing to double-sided natural tackiness, the material can build up a good heat conduction path between the heat sink and the metal substrate during assembly. The product shows low thermal resistance and good electrical insulation properties under low compression force.

Features

- Thermal Conductivity
  3.0 W/m·K
- Natural Tackiness
- Low Compress Stress
- Low Thermal Resistance

Applications

- Consumer Electronics
- Network Equipment
- Voltage Regulation Modules
- High Speed Storage Drive

Property	Typical Value	Unit	Test Method
Composition	Silicone Filled with Thermal Powder &		—
Color	Pink	—	Visual
Thermal Conductivity	3.0	W/m·K	ASTM D5470
Thickness			

All technical information stated in this technical data have been confirmed that all the technical parameters are reliable after harsh testing and evaluation of the products. Before you use our products, please carefully evaluate and decide whether the product meets your requirement and you need to take all the risks and responsibilities to use.